



PATENT

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# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: SUNG-FEI WANG

SERIAL NO.: 10/809,384

FILED: March 26, 2004

FOR: Flip-Chip Package With Reinforced Bumps

GROUP ART UNIT: 2811

EXAMINER: Unassigned

ATTY. REFERENCE: WANG3232/EM

## COMMISSIONER OF PATENTS

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

The below identified communication(s) or document(s) is(are) submitted in the above application or proceeding:

☒ Supplemental Application Data Sheet

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☒ Please debit or credit **Deposit Account Number 02-0200** for any deficiency or surplus in connection with this communication.

☐ Small Entity Status is claimed.

☐

23364

CUSTOMER NUMBER

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Date: October 8, 2004

*Respectfully submitted,*

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